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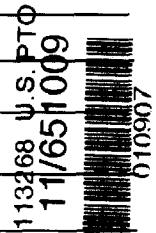
To the Director of the U.S. Patent &

documents or the new address(es) below.

709.1

1. Name of conveying party(ies)
Seiko Epson Corporation
Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)
Name: Transmeta Corporation
Internal Address: _____
Street Address: 3940 Freedom Circle
City: Santa Clara
State: California
Country: United States Zip: 95054
Additional name(s) & address(es) attached? Yes No



3. Nature of conveyance/Execution Date(s):
Execution Date(s) 05/24/2001
 Assignment Merger
 Security Agreement Change of Name
 Joint Research Agreement
 Government Interest Assignment
 Executive Order 9424, Confirmatory License
 Other _____

4. Application or patent number(s): This document is being filed together with a new application.
A. Patent Application No.(s)
To Be Assigned
B. Patent No.(s)
Additional numbers attached? Yes No

5. Name and address to whom correspondence concerning document should be mailed:
Name: Sterne, Kessler, Goldstein & Fox P.L.L.C.
Internal Address: c/o Thomas C. Fiala
Street Address: 1100 New York Avenue, N.W.
City: Washington
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Fax Number: 202-371-2540
Email Address: tfiala@skgf.com

6. Total number of applications and patents involved: 1
7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00
 Authorized to be charged by credit card
 Authorized to be charged to deposit account
 Enclosed
 None required (government interest not affecting title)

8. Payment Information
a. Credit Card Last 4 Numbers 1005
Expiration Date 08/2009
b. Deposit Account Number 19-0036
Authorized User Name SKGF PLLC

9. Signature: [Signature] Signature January 9, 2007 Date

Thomas C. Fiala Name of Person Signing
Total number of pages including cover sheet, attachments, and documents: 5

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450

01/10/2007 BABRAHA1 00000017 11651009

628,893

06 FC:8021 (40.00 DP)

CONFIDENTIAL - Subject to Nondisclosure Agreement**ASSIGNMENT OF PATENTS**

Whereas, SEIKO EPSON CORPORATION, a Japanese corporation having its principal place of business at 3-5, Owa 3-Chome, Suwa-shi, Nagano-ken, 392-8502 Japan, (hereinafter referred to as "Assignor"), is the assignee of record of certain U.S. patents and the foreign counterparts to such patents and any continuations, divisions, reissues, reexaminations of such patents (hereinafter referred to as the "Patents"); such patents being listed in Exhibit A attached hereto and incorporated herein by reference thereto;

Whereas, TRANSMETA CORPORATION, a Delaware corporation, having its principal place of business at 3940 Freedom Circle, Santa Clara, California 95054 U.S.A., (hereinafter referred to as "Assignee"), is desirous of acquiring the entire right, title and interest in the Patents;

Now, therefore, in consideration of good and valuable consideration, receipt of which is hereby acknowledged, SEIKO EPSON CORPORATION, the Assignor and owner of the entire unencumbered right, title and interest in said Patents, does hereby sell, assign and transfer unto said Assignee the entire right, title and interest in and to the Patents aforesaid along with any past claims for infringement thereof and any divisions, continuations, and foreign counterparts thereof; the same to be held and enjoyed by the said Assignee for its own use and benefit, and for its legal representatives and assigns, to the full ends of the terms for which said

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Patents are granted, as fully and entirely as the same would have been held by Assignor had this assignment and sale not been made.

Executed this 24 day of May, 2001, at Suwa of Japan.

SEIKO EPSON CORPORATION
(Assignor)

By 
Masataka Kamiyanagi
Director

Attachment

Final Agreement

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CONFIDENTIAL – Subject to Nondisclosure AgreementExhibit AList of Patents and Patent Applications

Family 1: RISC microprocessor architecture implementing multiple typed register sets

U.S. Patent No. 6,044,449
U.S. Patent No. 5,838,986
U.S. Patent No. 5,682,546
U.S. Patent No. 5,560,035
U.S. Patent No. 5,493,687
U.S. Patent Application No. 09/480,136
U.S. Patent Application No. 09/840,026
European Patent No. 547216
Great Britain Patent No. 547216
German Patent No. 69230057.0
French Patent No. 547216
Hong Kong Patent Application No. 99104718.5
European Patent Application No. 99102406.8
Korean Patent No. 0294964
JP Application No. 93/502403

Family 2: Superscalar RISC instruction scheduling

U.S. Patent No. 5,974,526
U.S. Patent No. 5,737,624
U.S. Patent No. 5,497,499
U.S. Patent Application No. 09/329,352 (this application is being abandoned and a new continuation application is scheduled to be filed before July 2, 2001)
U.S. Patent Application No. 09/329,354
European Patent No. 636256
Great Britain Patent No. 636256
German Patent No. 69311330.8
French Patent No. 636256
Korean Patent No. 0294277
Korean Patent Application No. 10-2000-7014693
Korean Patent Application No. 10-2000-7014694
JP Application No. 93/517293
JP Application No. 2000/8149
JP Application No. 2000/8148
JP Application No. 2000/8147
JP Application No. 2000/8146
JP Application No. 2000/8145
JP Application No. 2000/8144

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Family 3: Superscalar microprocessor for out-of-order and concurrently executing at least two RISC instructions translating from in-order CISC instructions

- U.S. Patent No. 5,983,334
- U.S. Patent No. 5,619,666
- U.S. Patent No. 5,546,552
- U.S. Patent No. 5,438,668
- U.S. Patent Application No. 09/401,860
- U.S. Patent Application (a new continuation of allowed U.S. Patent Application No. 09/401,860) filed on May 10, 2001 but no serial number yet received from the PTO
- European Patent No. 636257
- Great Britain Patent No. 636257
- German Patent No. 69329644.5
- French Patent No. 636257
- Hong Kong Patent Application No. 98116064.0
- European Patent Application No. 00108579.4
- Korean Patent Application No. 10-1994-0703361
- Korean Patent Application No. 10-2001-7005744
- JP Application No. 93/517306
- JP Application No. 2000/7265
- JP Application No. 2000/7264
- JP Application No. 2000/7263
- JP Application No. 2000/7262
- JP Application No. 2000/7261
- JP Application No. 2000/7260
- JP Application No. 2000/7259
- JP Application No. 2000/7258